



2836/9

DOCKET NO: VSEA 16-99

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Grant Kenji Larsen  
Serial No: 09/676,548  
Confirmation No: 2719  
Filed: September 29, 2000  
For: SURFACE STRUCUTRE AND METHOD OF MAKING, AND  
ELECTROSTATIC WAFER CLAMP INCORPORATING  
SURFACE STRUCTURE  
Examiner: Stephen W. Jackson  
Art Unit: 2836

**CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the 10<sup>th</sup> day of June, 2003.

*Cheryl A. Russell*  
Cheryl Russell

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:  
Transmitted herewith are the following documents:

- ☒ Response Under 37 CFR § 1.111
- ☒ Petition for Extension of Time
- ☒ Terminal Disclaimer
- ☒ Return Receipt Postcard

If any additional fees are determined to be required or if there are any overpayments,

Deposit Account 50-0896 may be charged or credited. A duplicate of this sheet is enclosed.

Respectfully submitted,  
**Grant Kenji Larsen, Applicant**

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Docket No. VSEA 16-99

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